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NMC27C32 32,768-Bit (4096 x 8) UV Erasable CMOS PROM

General Description

The NMC27C32 is a high speed 32k UV erasable and electrically reprogrammable CMOS EPROM, ideally suited for applications where fast turnaround, pattern experimentation and low power consumption are important requirements.

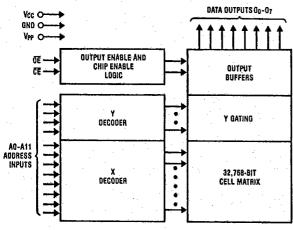
The NMC27C32 is packaged in a 24-pin dual-in-line package with transparent lid. The transparent lid allows the user to expose the chip to ultraviolet light to erase the bit pattern. A new pattern can then be written into the device by following the programming procedure.

This EPROM is fabricated with the reliable, high volume, time proven, p²CMOSTM silicon gate technology.

Features

- Access time down to 300 ns
- Low CMOS power consumption Active power: 26.25 mW max Standby power: 0.53 mW max (98% savings)
- Extended temperature range available (NMC27C32E-45 and NMC27C32HE-45), -40°C to +85°C, 450 ns ±5% power supply
- 10 ms programming available (NMC27C32H), an 80% time savings
- Pin compatible to NMC2732 and higher density EPROMs
- Static-no clocks required
- TTL compatible inputs/ outputs
- Two-line control
- TRI-STATE® output

Block Diagram



Pin Names

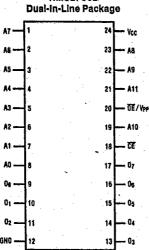
A0-A11	Addresses
CE	Chip Enable
ŌĒ	Output Enable
00-07	Outputs

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Connection Diagram

27C256	270128	27C64	27C16
27256	27128	2764	2716
Vpp	Vpp	V _{PP}	
Á12	A12	A12	
A7	A7 .	A7	A7
A6	A6	A6	A6
A5	A5	A5	A5
A4	A4	A4	A4
A3	A3	A3	A3
A2	A2	A2	A2
A1	A1	A1	A1
A0	A0	AO	AO
00	00	00	00
01	Oi	01	01
02	02	02	02
GND	GND	GND	GND

NMC27C32 Dual-In-Line Package



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27C216	27C64	27C128	27C256
27216	2764	27128	27256
	Vcc	Vcc	Vcc
ļ	PGM	PGM	A14
Vcc	NC	A13	A13
A8	A8	- A8	. A8
A9	A9	A9	A9
V _{PP}	A11	A11	A11
ŌĒ	ŌĒ	ŌĒ	ŌĒ
A10	A10	A10	A10
CE	Œ	CE	CE
07	07	0,7	07
06	06	06	06
05	05	O ₅	05
04	04	04	04
03	03	03	03

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Top View

Order Number NMC27C32 See NS Package Number J24AQ

Note: Socket compatible EPROM pin configurations are shown in the blocks adjacent to the NMC27C32 pins.

Commercial Temp Range (0°C to +70°C) $V_{CC} = 5V \pm 5\%$

Parameter/Order Number	Access Time (ns)
NMC27C32-30, NMC27C32H-30	300
NMC27C32-35, NMC27C32H-35	350
NMC27C32-45, NMC27C32H-45	450
NMC27C32-55, NMC27C32H-55	550

Extended Temp Range (-40° C to $+85^{\circ}$ C) $V_{CC} = 5V \pm 5\%$

Parameter/Order Number	Access Time (ns)
NMC27C32E-45, NMC27C32EH-45	450



Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Temperature under Bias

-10°C to +80°C

Storage Temperature All Input Voltages with -65°C to +125°C

Respect to Ground

+6.5V to -0.3V

All Output Voltages with

Respect to Ground

V_{CC} + 0.3V to GND -0.3V

V_{PP} Supply Voltage with Respect to Ground during Programming

+26.5V to -0.3V

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Power Dissipation

Lead Temperature (Soldering, 10 seconds)

1.0W-300°C

Operating Conditions (Note 7)

Temperature Range

NMC27C32-30, NMC27C32-35, NMC27C32-45, NMC27C32-55, NMC27C32H-30, NMC27C32H-35,

NMC27C32H-45, NMC27C32H-55

NMC27C32HE-45, NMC27C32E-45

V_{CC} Power Supply

0°C to +70°C 40°C to +85°C

5V ±5%

READ OPERATION

DC Electrical Characteristics

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
l <u>u</u>	Input Load Current	V _{IH} = V _{CC} or GND			10	μΑ
ILO	Output Leakage Current	$V_{OUT} = V_{CC}$ or GND, $\overline{CE} = V_{IH}$			10	μA
lcc1	V _{CC} Current (Active) TTL Inputs	$\overrightarrow{OE} = \overrightarrow{CE} = V_{IL}$ Inputs = V_{IH} or V_{IL} , $f = 1$ MHz I/O = 0 mA		2	10	mA
I _{CC2}	V _{CC} Current (Active) CMOS Inputs	OE = CE = V _{IL} Inputs = V _{CC} or GND, f = 1 MHz I/O = 0 mA		1	5	mΑ
Iccset	V _{CO} Current (Standby) TTL Inputs	CE = V _{IH}		0.1	1	mA
ICCSB2	V _{CC} Current (Standby) CMOS Inputs	CE = V _{CC}		0.01	0.1	mA
VIL	Input Low Voltage		-0.1		0.8	V.
VIH	Input High Voltage		2.0		V _{CC} + 1	٧
V _{OL1}	Output Low Voltage	I _{OL} = 2.1 mA			0.45	٧
V _{OH1}	Output High Voltage	I _{OH} = -400 μA	2.4			٧
V _{OL2}	Output Low Voltage	I _{OL} = 0 μA		8. H. S.	0.1	٧
V _{OH2}	Output High Voltage	l _{OH} = 0 μA	V _{CC} - 0.1			٧

AC Electrical Characteristics

		e la	NMC27C32								
Symbol	Parameter	Conditions	-30,	H-30	-35,	H-35		H-45 HE-45	-55,	H-55	Units
			Min	Max	Min	Max	Min	Max	Min	Max	ļ. ·
tACC	Address to Output Delay	CE = OE = VIL		300		350		450		550	ns
tce	CE to Output Delay	OE = VIL		300		350		450		550	ns
toE	OE to Output Delay	CE = VIL		150		150		150		150	ns
tor	OE High to Output Float	CE = VIL	0	130	0	130	0	130	0	130	ns
toн (Note 3)	Output Hold from Addresses, CE or OE, Whichever Occurred First	CE = OE = VIL	0		0		0		0		ns

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Capacitance TA = +25°C, f = 1 MHz (Note 3)

Symbol	Parameter	Conditions	Тур	Max	Units
C _{IN1}	Input Capacitance Except OE/V _{PP}	V _{IN} = 0V	4	6	pF
C _{IN2}	OE/V _{PP} Input Capacitance	V _{IN} = 0V		20	рF
COUT	Output Capacitance	V _{OUT} = 0V	8	12	pF

AC Test Conditions

Output Load

1 TTL Gate and C_L = 100 pF

Timing Measurement Reference Level

Inputs Outputs

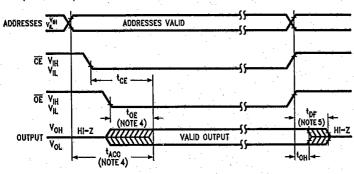
1V and 2V 0.8V and 2V

Input Rise and Fall Times Input Pulse Levels

0.45V to 2.4V

≤20 ns

AC Waveforms (Notes 6 & 8)



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Note 1: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: Typical values are for TA = +25°C and nominal supply voltages

Note 3: This parameter is only sampled and is not 100% tested.

Note 4: $\overrightarrow{\text{OE}}$ may be delayed up to tacc - top after the falling edge of $\overrightarrow{\text{CE}}$ without impacting tacc.

Note 5: The t_{DF} compare level is determined as follows: High to TRI-STATE, the measured V_{OH1} (DC) — 0.10V; Low to TRI-STATE, the measured V_{OH1} (DC) + 0.10V.

Note 6: TRI-STATE may be attained using \widetilde{OE} or \overline{CE} .

Note 7: The power switching characteristics of EPROMs require careful device decoupling. It is recommended that a 0.1 µF ceramic capacitor be used on every device between V_{CC} and GND.

Note 8: The outputs must be restricted to V_{CC} + 0.3V to avoid latch-up and device damage.

PROGRAMMING (Note 1)

DC Programming Characteristics $T_A = +25^{\circ}C$, $V_{CC} = 5V \pm 5\%$, $V_{PP} = 25V \pm 1V$ (Notes 2 and 3)

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Symbol	Parameter	Conditions	Min	Тур	Max	Units
l _{Ll}	Input Current (All Inputs)	V _{IN} = V _{CC} or GND			10	μА
VOL	Output Low Voltage During Verify	I _{OL} = 2.1 mA			0.45	٧
VOH	Output High Voltage During Verify	$I_{OH} = -400 \mu\text{A}$	2.4			٧
lcc	V _{CC} Supply Current			2	10	mA
VIL	Input Low Level (All Inputs)		-0.1		0.8	V.
V _{iH}	Input High Level (All Inputs except OE/V _{PP})		2.0		V _{CC} + 1	٧
Ірр	V _{PP} Supply Current	$\overline{CE} = V_{IL}, \overline{OE} = V_{PP}$			30	mA:

AC Programming Characteristics $T_A = +25^{\circ}C \pm 5^{\circ}C$, $V_{CC} = 5V \pm 5\%$, $V_{PP} = 25V \pm 1V$

Symbol	Parameter	Conditions	NMC27C32			NMC27C32H			Units
-,		Conditions	Min	Тур	Max	Min	Тур	Max	Omis
tas	Address Setup Time		2			2			μs
toes	OE Setup Time		2			2			μs
t _{DS}	Data Setup Time		2			2			μs
t _{AH}	Address Hold Time		.0			0:			μs
toen	OE Hold Time		2			2			μз
toH	Data Hold Time	•	2			2			μз
tor	Chip Enable to Output Float Delay		0		130	0		130	ns
tov	Data Valid from CE	$\overline{CE} = V_{IL}, \overline{OE} = V_{IL}$			1			1	μз
tpw	CE Pulse Width during Programming		45	- 50	55	9	10	11	ms
tpat	OE Pulse Rise Time during Programming		50			50			ns
t _{VR}	V _{PP} Recovery Time		2		<u> </u>	2			μs

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AC Test Conditions

Input Rise and Fall Times Input Pulse Levels

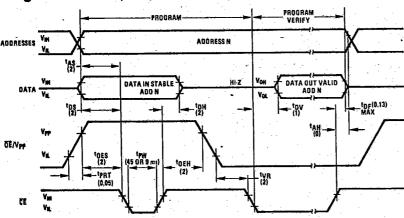
5V ± 5% 25V ± 1V ≤20 ns

0.45V to 2.4V

Timing Measurement Reference Level Inputs Outputs

1V and 2V 0.8V and 2V

Programming Waveforms (Note 3)



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Note: All times shown in parentheses are minimum and in μs unless otherwise specified. The input timing reference level is 1V for a V_{IL} and 2V for a V_{IH} .

Note 1: National's standard product warranty applies only to devices programmed to specifications described herein

Note 2: VCO must not be applied simultaneously or before Vpp and removed simultaneously or after Vpp. The NMC27C32 must not be inserted into or removed from a board with Vpp at 25V ± 1V to prevent damage to the device.

Note 3: The maximum allowable voltage which may be applied to the Vpp pin during programming is 26V. Care must be taken when switching the Vpp supply to prevent overshoot exceeding this 26V maximum specification. A 0.1 µF capacitor is required across Voc to GND to suppress spurious voltage translents which may damage the device.

Functional Description (Continued)

DEVICE OPERATION

The 6 modes of operation of the NMC27C32 are listed in Table I. A single 5V power supply is required in the read mode. All inputs are TTL levels except for OE/Vpp during programming. In the program mode the OE/Vpp input is pulsed from a TTL level to 25V.

Read Mode

The NMC27C32 has two control functions, both of which must be logically active in order to obtain data at the outputs. Chip Enable (CE) is the power control and should be used for device selection. Output Enable (\overline{OE}) is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that addresses are stable, address access time (tACC) is equal to the delay from $\overline{\text{CE}}$ to output (t_{CE}). Data is available at the outputs after the falling edge of $\overline{\text{OE}}$, assuming that $\overline{\text{CE}}$ has been low and addresses have been stable for at least tACC-toE.

Standby Mode

The NMC27C32 has a standby mode which reduces the active power dissipation by 98%, from 26.25 mW to 0.53 mW. The NMC27C32 is placed in the standby mode by applying a TTL high signal to the CE input. When in standby mode, the outputs are in a high impedance state, independent of the OE Input.

Output OR-Tying

Because EPROMS are usually used in larger memory arrays, National has provided a 2-line control function that accommodates this use of multiple memory connection. The 2-line control function allows for:

- a) the lowest possible memory power dissipation, and
- b) complete assurance that output bus contention will not

To most efficiently use these two control lines, it is recommended that CE (pin 18) be decoded and used as the primany device selecting function, while OE (pin 20) be made a common connection to all devices in the array and connected to the READ line from the system control bus. This assures that all deselected memory devices are in their low power standby modes and that the output pins are active only when data is desired from a particular memory device.

Programming

CAUTION: Exceeding 26.5V on pin 20 (VPP) will damage the NMC27C32.

Initially, and after each erasure, all bits of the NMC27C32 are in the "1" state. Data is introduced by selectively programming "0s" into the desired bit locations. Although only "0s" will be programmed, both "1s" and "0s" can be presented in the data word. The only way to change a "0" to a "1" is by ultraviolet light erasure.



Functional Description (Continued)

The NMC27C32 is in the programming mode when the $\overline{\text{OE}}/\text{Vpp}$ input is at 25V. It is required that a 0.1 μF capacitor be placed across $\overline{\text{OE}}/\text{Vpp}$, V_{CC} , and ground to suppress spurious voltage transients which may damage the device. The dafa to be programmed is applied 8 bits in parallel to the data output pins. The levels required for the address and data inputs are TTL.

When the address and data are stable, a 50 ms (10 ms for the NMC27C32H devices) active low TTL program pulse is applied to the $\overline{\text{CE}}$ input. A program pulse must be applied at each address location to be programmed, You can program any location at any time—either individually, sequentially, or at random. The program pulse has a maximum width of 55 ms (11 ms for the NMC27C32H devices). The NMC27C32 must not be programmed with a DC signal applied to the $\overline{\text{CE}}$ input.

Programming of multiple NMC27C32s in parallel with the same data can easily be accomplished due to the simplicity of the programming requirements. Like inputs of the paralleled NMC27C32s may be connected together when they are programmed with the same data. A low level TTL pulse applied to the CE input programs the paralleled NMC27C32s.

Program inhibit

Programming multiple NMC27C32s in parallel with different data is also easily accomplished. Except for CE, all like inputs (including OE) of the parallel NMC27C32s may be common. A TTL level program pulse applied to an NMC27C32's CE input with OE/Vpp at 25V will program that NMC27C32. A high level CE input inhibits the other NMC27C32s from being programmed.

Program Verify

A verify should be performed on the programmed bits to determine whether they were correctly programmed. The verify is accomplished with \overline{OE}/V_{PP} and \overline{CE} at V_{IL} . Data should be verified toy after the falling edge of \overline{CE} .

ERASURE CHARACTERISTICS

The erasure characteristics of the NMC27C32 are such that erasure begins to occur when exposed to light with wavelengths shorter than approximately 4000 Angstroms (Å). It should be noted that sunlight and certain types of fluorescent lamps have wavelengths in the 3000Å-4000Å range. After programming, opaque labels should be placed over

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the NMC27C32 window to prevent unintentional erasure. Covering the window will also prevent temporary functional failure due to the generation of photo currents.

The recommended erasure procedure for the NMC27C32 is exprosure to shortwave ulfraviolet light which has a wavelength of 2537 Angstroms (Å). The integrated dose (i.e., UV intensity x exposure time) for erasure should be a minimum of 15W-sec/cm². The erasure time with this dosage is approximately 21 minutes using an ultraviolet lamp with a 12,000 µW/cm² power rating. The NMC27C32 should be placed within 1 inch of the lamp tubes during erasure. Some lamps have a filter on their tubes which should be removed before erasure.

Note: The NMC27G32-55 and NMC27G32H-55 may take up to 60 minutes for complete erasure to occur.

An erasure system should be calibrated periodically. The distance from lamp to unit should be maintained at one inch. The erasure time increases as the square of the distance. (If distance is doubled the erasure time increases by a factor of 4.) Lamps lose intensity as they age. When a lamp is changed, the distance has changed or the lamp has aged, the system should be checked to make certain full erasure is occuring. Incomplete erasure will cause symptoms that can be misleading. Programmers, components, and even system designs have been erroneously suspected when incomplete erasure was the problem.

SYSTEM CONSIDERATION

The power switching characteristics of EPROMs require careful decoupling of the devices. The supply current, ICG, has three segments that are of interest to the system designer-the standby current level, the active current level, and the transient current peaks that are produced on the falling and rising edges of chip enable. The magnitude of these transient current peaks is dependent on the output capacitance loading of the device. The associated transient voltage peaks can be suppressed by properly selected decoupling capacitors. It is recommended that a 0.1 µF ceramic capacitor be used on every device between VCC and GND. This should be a high frequency capacitor of low inherent inductance. In addition, a 4.7 µF bulk electrolytic capacitor should be used between VCC and GND for each eight devices. The bulk capacitor should be located near where the power supply is connected to the array. The purpose of the bulk capacitor is to overcome the voltage drop caused by the inductive effects of the PC board traces.

TABLE I. Mode Selection

Pins	CE	OE/V _{PP}	Vcc	Outputs	
Mode	(18)	(20)	(24)	(9-11, 13-17	
Read	V _{IL}	V _{IL}	5	D _{OUT}	
Standby	V _{IH}	Don't Care	5	Hi-Z	
Output Disable	Don't Care	V _{IH}	5	Hi-Z	
Program	V _{IL}	Vpp	5	D _{IN}	
Program Verify	V _{IL}	V _{IL}	5	D _{OUT}	
Program Inhibit	V _{IH}	V _{PP}	5	Hi-Z	